506246335 09/10/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6293080

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
WEIWEN ZHONG	09/09/2020

RECEIVING PARTY DATA

Name:	UNITED MICROELECTRONICS CORP.	
Street Address:	No.3, Li-Hsin Road 2, Science-Based Industrial Park	
City:	Hsin-Chu City	
State/Country:	TAIWAN	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17017655

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	NAUP3701USA
NAME OF SUBMITTER:	SIBYL YU
SIGNATURE:	/SIBYL YU/
DATE SIGNED:	09/10/2020

Total Attachments: 2 source=3954003#page1.tif source=3954003#page2.tif

PATENT 506246335 REEL: 053740 FRAME: 0239

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention:

METHOD FOR FORMING SEMICONDUCTOR STRUCTURE

As the below named inventor, I here This declaration is directed to:	by declare that:		
☑ The attached application, or			
☐ United States application number		filed on	, or
☐ PCT international application number		filed on	
The above-identified application was	made or authorized to be made	by me.	
I believe that I am the original invent application.	or or an original joint inventor of	a claimed invention in the	
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impr	I false statement made in this de isonment of not more than five (5	claration is punishable i) years, or both.	
In consideration of the payment by	UNITED MICROELECTRO	NICS having a postal add	dress of
No.3, Li-Hsin Road 2, Science	-Based Industrial Park, Hs	in-Chu City 300, Taiwar	ı, R.O.C.
(referred to as "ASSIGNEE"below) to acknowledged, and for other good are	o I of the sum of One Dollar (\$ 1.6 d valuable consideration.	00), the receipt of which is he	ereby
I hereby sell, assign and transfer to ASSIGNEE and the successors and assignees of the ASSIGNEE the entire right, title and interest in and to any and all improvements which are disclosed in the invention as above-identified application and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof.			
I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;			
I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal			
representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof. IN WITNESS WHEREOF, I have hereunto set hand and seal this on the date(s) indicated.			
Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire inventive entity, must accompany this form. Use this form for each additional inventor.			

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NPO#NAU-P3701-USA:0 CUST#UMCD-2020-0252

F#NPO-P0002E-US1201 DSB0-109U027175

Docket No NAUP3701USA

LEGAL NAI	ME OF INVENTOR(ASSIGNOR)		
Inventor:	WEIWEN ZHONG	Date:	SEP 0 9 2020
Signature:	2 honguerren		

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NPO#NAU-P3701-USA:0 CUST#UMCD-2020-0252

RECORDED: 09/10/2020

F#NPO-P0002E-US1201 DSB0-109U027175

PATENT REEL: 053740 FRAME: 0241